# MURD530T4G, SURD8530T4G, SURD8530T4G-VF01

# Switch-mode Power Rectifier

# **DPAK Surface Mount Package**

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

#### **Features**

- Ultrafast 50 Nanosecond Recovery Time
- Low Forward Voltage Drop
- Low Leakage
- SURD8 Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

#### **MAXIMUM RATINGS**

| Rating   | Symbol   | Value       | Unit |
|--|--|-------------|------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage                     | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 300         | V    |
| Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>C</sub> = 165°C)                          | I <sub>F(AV)</sub>                                     | 5.0         | Α    |
| Peak Repetitive Forward Current<br>(Rated V <sub>R</sub> , Square Wave,<br>20 kHz, T <sub>C</sub> = 165°C) | I <sub>FRM</sub>                                       | 10          | Α    |
| Non-Repetitive Peak Surge Current<br>(Surge Applied at Rated Load<br>Conditions Halfwave, 60 Hz)           | I <sub>FSM</sub>                                       | 75          | Α    |
| Operating Junction and Storage<br>Temperature Range  | T <sub>J</sub> , T <sub>stg</sub>                      | -65 to +175 | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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## ULTRAFAST RECTIFIER 5.0 AMPERES, 300 VOLTS



DPAK CASE 369C



#### **MARKING DIAGRAM**



U530 = Specific Device Number

= Assembly Location\*

Y = Year WW = Work Week G = Pb-Free Package

#### **ORDERING INFORMATION**

| Device               | Package           | Shipping <sup>†</sup>      |
|----------------------|-------------------|----------------------------|
| MURD530T4G           | DPAK<br>(Pb-Free) | 2,500/Tape & Reel<br>16 mm |
| SURD8530T4G          | DPAK<br>(Pb-Free) | 2,500/Tape & Reel<br>16 mm |
| SURD8530T4G-<br>VF01 | DPAK<br>(Pb-Free) | 2,500/Tape & Reel<br>16 mm |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>\*</sup> The Assembly Location Code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

#### THERMAL CHARACTERISTICS

| Characteristic                                    | Symbol          | Value | Unit |
|---|-----------------|-------|------|
| Thermal Resistance – Junction–to–Case (Note 1)    | $R_{	heta JC}$  | 3     | °C/W |
| Thermal Resistance – Junction–to–Ambient (Note 2) | $R_{\theta JA}$ | 92    | °C/W |
| Thermal Resistance – Junction-to-Ambient (Note 3) | $R_{\theta JA}$ | 57    | °C/W |

- 1. Rating applies for one diode leg.
- Rating applies when for both diode legs when mounted on 130 mm<sup>2</sup> pad size.
- 3. Rating applies for both diode legs when mounted on 1 in pad size.

#### **ELECTRICAL CHARACTERISTICS**

| Characteristic  | Symbol          | Value                        | Unit  |
|---|-----------------|------------------------------|-------|
| Maximum Instantaneous Forward Voltage Drop (Note 4)   | VF              | 0.95<br>0.80<br>1.05<br>0.90 | Volts |
| Maximum Instantaneous Reverse Current (Note 4) $(T_J = 25^{\circ}C, Rated dc Voltage)$ $(T_J = 125^{\circ}C, Rated dc Voltage)$         | İR              | 5.0<br>150                   | μА    |
| Maximum Reverse Recovery Time ( $I_F = 1 \text{ Amp, di/dt} = 50 \text{ A/}\mu\text{s, V}_R = 30 \text{ V, T}_J = 25^{\circ}\text{C}$ ) | t <sub>rr</sub> | 50                           | ns    |

4. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

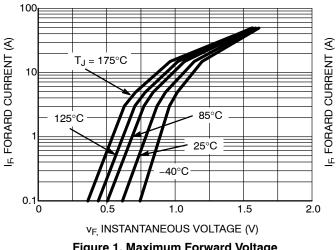


Figure 1. Maximum Forward Voltage

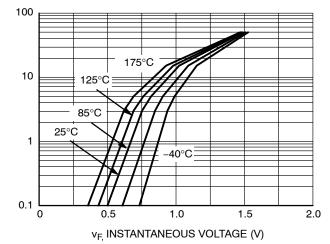


Figure 2. Typical Forward Voltage

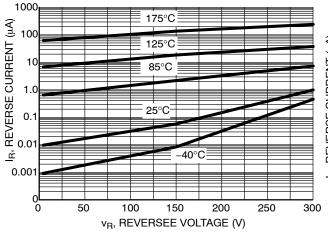


Figure 3. Maximum Reverse Voltage

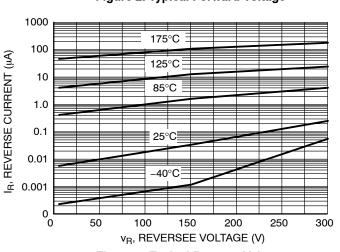


Figure 4. Typical Reverse Voltage

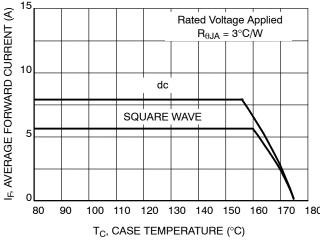


Figure 5. Typical Current Derating, Case

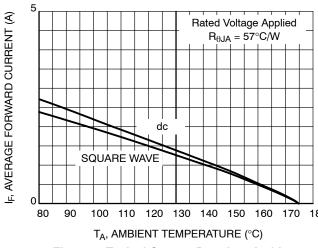


Figure 6. Typical Current Derating, Ambient

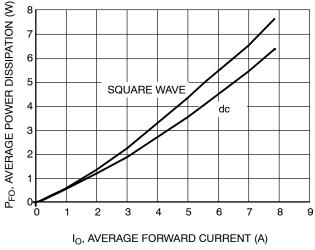


Figure 7. Forward Power Dissipation

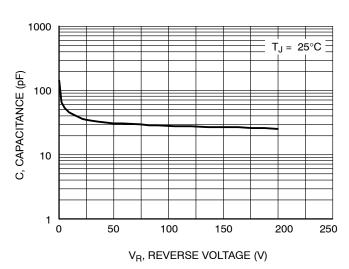


Figure 8. Typical Capacitance

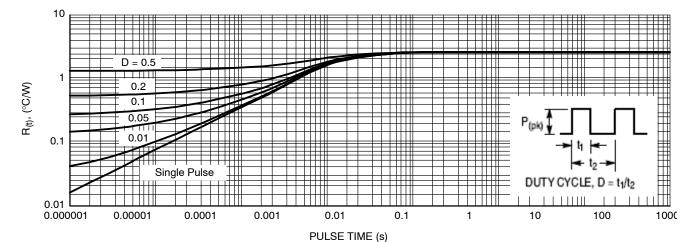


Figure 9.  $R_{(t)}$  on an Infinite Heatsink Power (J1) 0.800 W Power (J2) 0.800 W

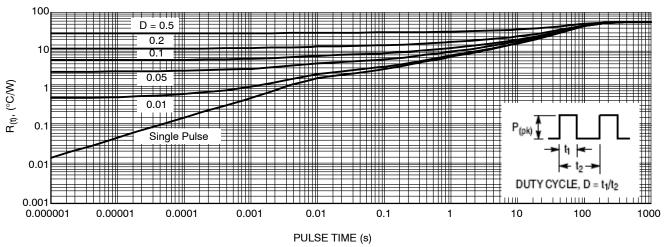
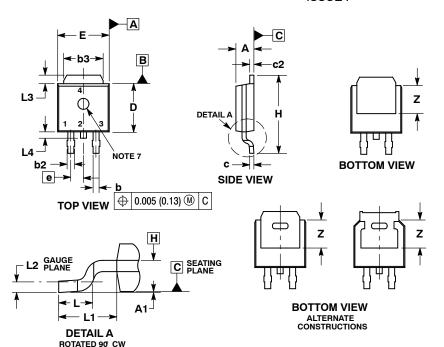


Figure 10. PCB Cu Area 650 mm² PCB Cu thk 1 oz Power (J1) 0.800 W Power (J2) 0.800 W

#### PACKAGE DIMENSIONS

#### **DPAK (SINGLE GAUGE)**

CASE 369C **ISSUE F** 

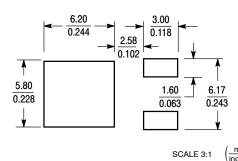


- 1. DIMENSIONING AND TOLERANCING PER ASME 714.5M, 1994.
  2. CONTROLLING DIMENSION: INCHES.
  3. THERMAL PAD CONTOUR OPTIONAL WITHIN DI-
- MENSIONS b3, L3 and Z.
  4. DIMENSIONS D AND E DO NOT INCLUDE MOLD
- FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
  5. DIMENSIONS D AND E ARE DETERMINED AT THE
- OUTERMOST EXTREMES OF THE PLASTIC BODY.

  6. DATUMS A AND B ARE DETERMINED AT DATUM
- PLANE H. 7. OPTIONAL MOLD FEATURE.

|     | INCHES    |       | MILLIMETERS |       |  |
|-----|-----------|-------|-------------|-------|--|
| DIM | MIN       | MAX   | MIN         | MAX   |  |
| Α   | 0.086     | 0.094 | 2.18        | 2.38  |  |
| A1  | 0.000     | 0.005 | 0.00        | 0.13  |  |
| b   | 0.025     | 0.035 | 0.63        | 0.89  |  |
| b2  | 0.028     | 0.045 | 0.72        | 1.14  |  |
| b3  | 0.180     | 0.215 | 4.57        | 5.46  |  |
| С   | 0.018     | 0.024 | 0.46        | 0.61  |  |
| c2  | 0.018     | 0.024 | 0.46        | 0.61  |  |
| D   | 0.235     | 0.245 | 5.97        | 6.22  |  |
| E   | 0.250     | 0.265 | 6.35        | 6.73  |  |
| е   | 0.090 BSC |       | 2.29 BSC    |       |  |
| Н   | 0.370     | 0.410 | 9.40        | 10.41 |  |
| L   | 0.055     | 0.070 | 1.40        | 1.78  |  |
| L1  | 0.114 REF |       | 2.90 REF    |       |  |
| L2  | 0.020 BSC |       | 0.51 BSC    |       |  |
| L3  | 0.035     | 0.050 | 0.89        | 1.27  |  |
| L4  |           | 0.040 |             | 1.01  |  |
| Z   | 0.155     |       | 3.93        |       |  |

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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